SPDT, 1 Ω R_{ON} Switch

The NLAS5123 is a low R_{ON} SPDT analog switch. This device is designed for low operating voltage, high current switching of speaker output for cell phone applications. It can switch a balanced stereo output. The NLAS5123 can handle a balanced microphone/ speaker/ringtone generator in a monophone mode. The device contains a break-before-make (BBM) feature.

Features

- Single Supply Operation:
 - 1.65 V to 5.5 V V_{CC}
- Function Directly from LiON Battery
- R_{ON} Typical = 1.0 Ω @ V_{CC} = 4.5 V
- Low Static Power
- These are Pb–Free Devices

Typical Applications

- Cell Phone Speaker/Microphone Switching
- Ringtone-Chip/Amplifier Switching
- Stereo Balanced (Push-Pull) Switching

Important Information

- Continuous Current Rating Through each Switch ±300 mA
- 1.2 x 1.0 x 0.4P mm 6-Lead Thin DFN Package



ON Semiconductor®

http://onsemi.com

MARKING DIAGRAMS



W М • •

- W = Specific Device Code
- M = Date Code

UDFN6

MU SUFFIX CASE 517AA

WDFN6

MN SUFFIX

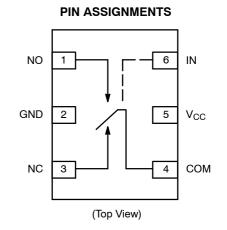
CASE 506AS

= Pb–Free Device



× M ●

- X = Specific Device Code
- M = Date Code
- = Pb-Free Device



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

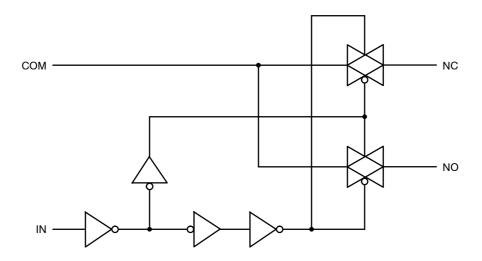


Figure 1. Input Equivalent Circuit

PIN DESCRIPTION

TRUTH TABLE

| Pin Name | Description |
|-------------|---------------|
| NC, NO, COM | Data Ports |
| IN | Control Input |

| Control Input | Function |
|---------------|---------------------|
| L | NC Connected to COM |
| Н | NO Connected to COM |

H = HIGH Logic Level. L = LOW Logic Level.

MAXIMUM RATINGS

| Symbol | Rating | Value | Unit |
|----------------------|---|------------------------------|------|
| V _{CC} | Positive DC Supply Voltage | -0.5 to +6.0 | V |
| V _{IS} | Analog Input Voltage (V _{NO} , V _{NC} , or V _{COM}) | –0.5 to V _{CC} +0.5 | V |
| V _{IN} | Digital Select Input Voltage | -0.5 to +6.0 | V |
| I _{anl1} | Continuous DC Current from COM to NC/NO | ±300 | mA |
| I _{anl-pk1} | Peak Current from COM to NC/NO, 10 Duty Cycles (Note 1) | ±500 | mA |
| I _{cImp} | Continuous DC Current into COM/NC/NO with respect to V_{CC} or GND | ±100 | mA |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Defined as 10% ON, 90% off duty cycle.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Rating | | Min | Max | Unit |
|---------------------------------|--|---|------|-----------------|------|
| V _{CC} | Positive DC Supply Voltage | | 1.65 | 5.5 | V |
| V _{IS} | Analog Input Voltage (NC, NO, COM) | | 0 | V _{CC} | V |
| V _{IN} | Digital Select Input Voltage (IN) | | 0 | V _{CC} | V |
| T _A | Operating Temperature Range | | -40 | 85 | °C |
| t _r , t _f | Input Rise or Fall Time, SELECT $V_{CC} = 3.0$ V _{CC} = 5.5 V _{CC} | / | | 20 10 | ns/V |

DC ELECTRICAL CHARACTERISTICS

| | | | V _{CC} | T _A = +25°C | | | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | | |
|------------------|---|---|-----------------|------------------------|-----|------|---|------------|------|
| Symbol | Parameter | Test Conditions | (V) | Min | Тур | Max | Min | Max | Unit |
| V _{IH} | HIGH Level Input Voltage | | 2.7 4.5 | | | | 2.0 2.4 | | V |
| V _{IL} | LOW Level Input Voltage | | 2.7 4.5 | | | | | 0.6 0.8 | V |
| I _{IN} | Input Leakage Current | $0 \le V_{IN} \le 5.5 V$ | 0–5.5 | | | ±0.1 | | ±1 | μA |
| I _{OFF} | OFF State Leakage Current (Note 7) | $0 \le NO, NC, COM \le V_{CC}$ | 5.5 | -2.0 | | +2.0 | | ±20 | nA |
| I _{ON} | ON State Leakage Current (Note 7) | $0 \le NO, NC, COM \le V_{CC}$ | 5.5 | -4.0 | | +4.0 | | ±40 | nA |
| R _{ON} | Switch On Resistance (Note 2) | $ I_O = 100 \text{ mA}, \\ V_{IS} = 0 \text{ V to } V_{CC} $ | 2.7 | | | 1.7 | | 2.0 | Ω |
| | | I_{O} = 100 mA, V _{IS} = 0 V to V _{CC} | 4.5 | | | 1.0 | | 1.2 | |
| I _{CC} | Quiescent Supply Current All Channels ON or OFF | $V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ | 5.5 | | | 0.5 | | 1.0 | μΑ |

Analog Signal Range

| ΔR _{ON} | On Resistance Match Between Channels (Notes 2, 3, 4) | | 2.7 4.5 | 0.15 0.12 | | 0.15 | Ω |
|-------------------|--|--|------------|--------------|--|------|---|
| R _{flat} | On Resistance Flatness (Notes 2, 3, 5) | $ I_A = 100 \text{ mA}, \\ V_{IS} = 0 \text{ V to } V_{CC} \\ I_A = 100 \text{ mA}, \\ V_{IS} = 0 \text{ V to } V_{CC} $ | 2.7 4.5 | 0.4 0.3 | | 0.4 | Ω |

2. Measured by the voltage drop between NC/NO and COM pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (NO, NC, COM).

3. Parameter is characterized but not tested in production. 4. $\Delta R_{ON} = R_{ON} \max - R_{ON} \min$ measured at identical V_{CC}, temperature and voltage levels.

5. Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of conditions. 6. Guaranteed by Design.

7. This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

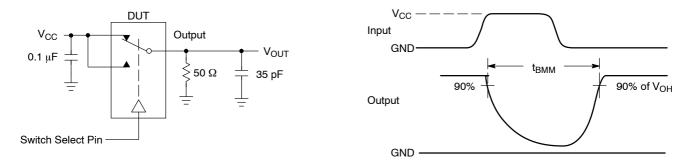
| | | | V _{CC} | T, | ₄ = +25° | С | T _A = -40°0 | C to +85°C | | Figure |
|--------------------------------------|---|---|-----------------|------------|----------|------------|------------------------|------------|------|--------|
| Symbol | Parameter | Test Conditions | (V) | Min | Тур | Max | Min | Max | Unit | # |
| t _{PHL} t _{PLH} | Propagation Delay Bus-to-Bus (Note 9) | $V_{IN} = V_{IH} \text{ or } V_{IL}$ | 2.7 4.5 | | | 2.0 0.3 | | | ns | |
| t _{ON} | Output Enable Time Turn On Time (COM to NO or NC) | | 2.7 4.5 | | | 30 20 | | 35 25 | ns | 3, 4 |
| t _{OFF} | Output Disable Time Turn Off Time (COM to NO, NC) | $ \begin{array}{l} {V_{IS} = 1.5 \text{V},} \\ {R_L = 50 \ \Omega , \ C_L = 35 \ \text{pF}} \\ {V_{IS} = 3.0 \ \text{V},} \\ {R_L = 50 \ \Omega , \ C_L = 35 \ \text{pF}} \end{array} $ | 2.7 4.5 | | | 20 15 | | 25 20 | ns | 3, 4 |
| t _{BBM} | Break Before Make Time (Note 8) | $\begin{array}{l} V_{IS} = 1.5 \text{V}, \\ \text{R}_{L} = 50 \ \Omega, \ \text{C}_{L} = 35 \ \text{pF} \end{array}$ | 2.7 4.5 | 0.5 0.5 | | | 0.5 0.5 | | ns | 2 |
| Q | Charge Injection (Note 8) | C_L = 1.0 nF, V_{GEN} = 0 V R _{GEN} = 0 Ω | 2.7 4.5 | | 26 48 | | | | рС | 6 |
| O _{IRR} | Off Isolation (Note 10) | R _L = 50 Ω f = 1.0 MHz | 2.7 – 5.5 | | -62 | | | | dB | 5 |
| X _{talk} | Crosstalk | R _L = 50 Ω f = 1.0 MHz | 2.7 – 5.5 | | -70 | | | | dB | 7 |
| BW | -3 dB Bandwidth | R _L = 50 Ω | 2.7 – 5.5 | | 55 | | | | MHz | 8 |
| THD | Total Harmonic Distortion (Note 8) | $R_L = 600 \Omega$ 0.5 V _{P-P} f = 20 Hz to 20 kHz | 2.7 – 5.5 | | 0.012 | | | | % | 9 |

8. Guaranteed by Design.
9. This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).
10. Off Isolation = 20 log₁₀ [V_{COM}/V_{NO,NC}].

CAPACITANCE (Note 11)

| Symbol | Parameter | Test Conditions | Тур | Max | Unit |
|--------------------|---|------------------------------------|-----|-----|------|
| C _{IN} | Select Pin Input Capacitance | V _{CC} = 0 V, f = 1 MHz | 2.0 | | pF |
| C _{NC/NO} | NC, NO Port Off Capacitance | V _{CC} = 4.5 V, f = 1 MHz | 20 | | pF |
| C _{COM} | COM Port Capacitance when Switch is Enabled | V _{CC} = 4.5 V, f = 1 MHz | 55 | | pF |

11. T_A = +25°C, f = 1 MHz, Capacitance is characterized but not tested in production.





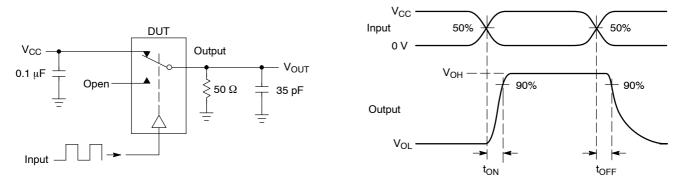
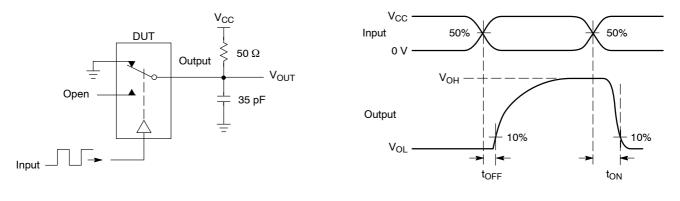
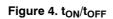
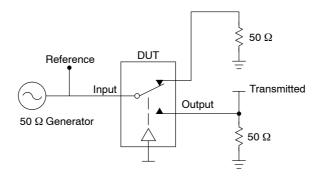


Figure 3. t_{ON}/t_{OFF}



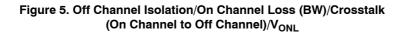




Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. V_{ISO} , Bandwidth and V_{ONL} are independent of the input signal direction.

$$\begin{split} V_{ISO} &= \text{Off Channel Isolation} = 20 \text{ Log } \left(\frac{V_{OUT}}{V_{IN}} \right) \text{ for } V_{IN} \text{ at } 100 \text{ kHz} \\ V_{ONL} &= \text{On Channel Loss} = 20 \text{ Log } \left(\frac{V_{OUT}}{V_{IN}} \right) \text{ for } V_{IN} \text{ at } 100 \text{ kHz to } 50 \text{ MHz} \end{split}$$

Bandwidth (BW) = the frequency 3 dB below V_{ONL} V_{CT} = Use V_{ISO} setup and test to all other switch analog input/outputs terminated with 50 Ω



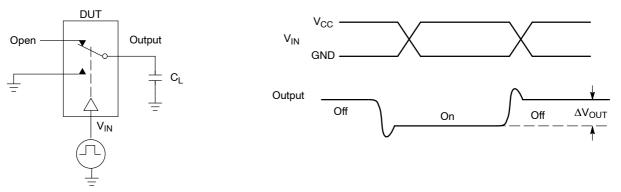
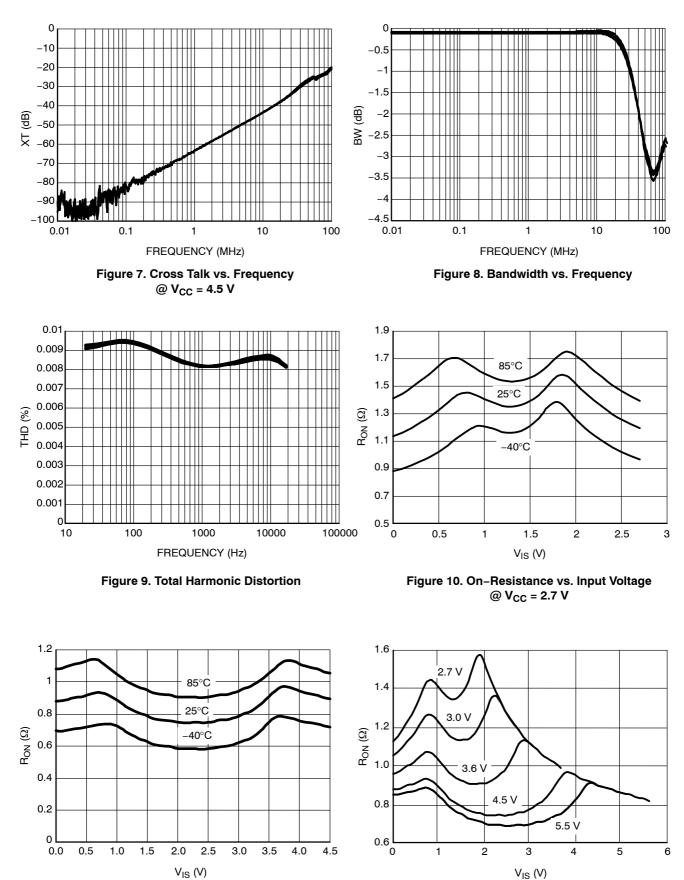


Figure 6. Charge Injection: (Q)



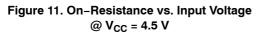


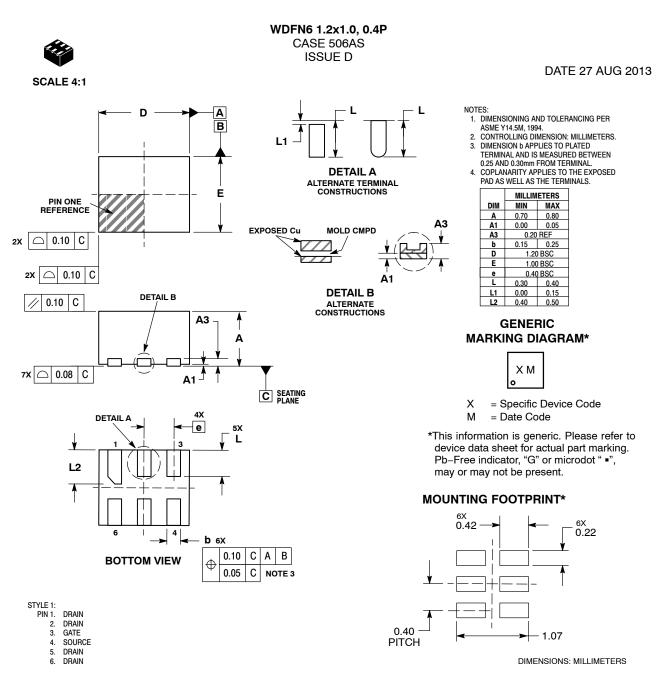
Figure 12. On-Resistance vs. Input Voltage

DEVICE ORDERING INFORMATION

| | | Devi | ce Nomenc | lature | | | |
|---------------------|----------------------|------------|--------------------|-------------------|-----------------------|--------------------|-------------------------------|
| Device Order Number | Circuit Indicator | Technology | Device Function | Package Suffix | Tape & Reel Suffix | Package Type | Tape & Reel Size [†] |
| NLAS5123MNR2G | NL | AS | 5123 | MN | 2 | WDFN6 (Pb-Free) | 3000 / Tape & Reel |
| NLAS5123MUR2G | NL | AS | 5123 | MU | 2 | UDFN6 (Pb-Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

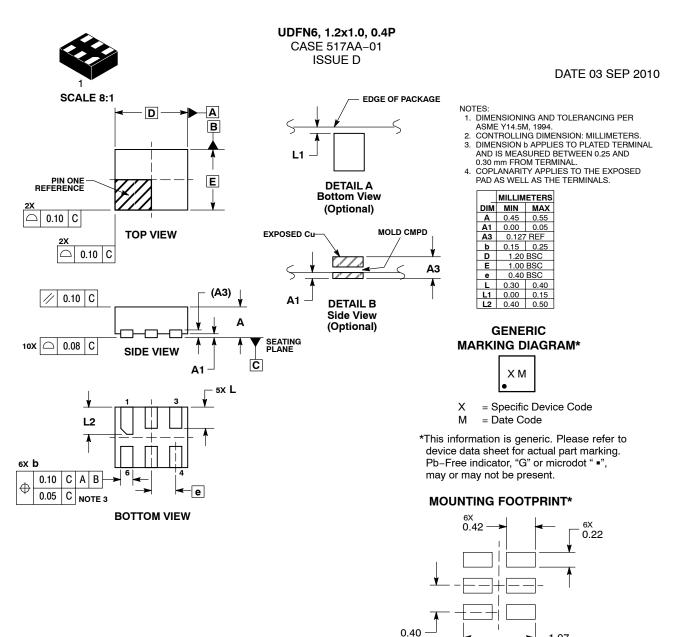




*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| DOCUMENT NUMBER: | 98AON21223D | Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | | | | | |
|--|-------------------------|---|-------------|--|--|--|--|--|
| DESCRIPTION: | WDFN6, 1.2 X 1.0, 0.4 P | | PAGE 1 OF 1 | | | | | |
| the suitability of its products for any pa | ON Semiconductor and | | | | | | | |





DIMENSIONS: MILLIMETERS

1.07

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PITCH

| DOCUMENT NUMBER: | 98AON22068D | Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | | | | |
|--|---------------------------|---|-------------|--|--|--|--|
| DESCRIPTION: | 6 PIN UDFN, 1.2X1.0, 0.4P | | PAGE 1 OF 1 | | | | |
| ON Semiconductor and I are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others. | | | | | | | |

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative